

**Application Data Sheet**

**Application Information**

Application Type::	National Phase
Subject Matter::	Utility
CD-ROM or CD-R:	None
Title::	METHOD FOR MANUFACTURING SEMICONDUCTOR WAFER, METHOD FOR RECEIVING ORDER FOR MANUFACTURE OF SEMICONDUCTOR WAFER, AND SYSTEM FOR RECEIVING ORDER FOR MANUFACTURE OF SEMICONDUCTOR WAFER
Attorney Docket Number::	120503
Total Drawing Sheets::	6
Small Entity::	No

**Applicant Information**

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Tatsuo
Family Name::	ITO
City of Residence::	Tokyo
Country of Residence::	Japan

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Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Shigeyoshi
Family Name::	NETSU
City of Residence::	Fukushima
Country of Residence::	Japan

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Applicant Authority type::	Inventor
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Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Masashi  
Family Name:: ICHIKAWA  
City of Residence:: Fukushima  
Country of Residence:: Japan

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Applicant Authority type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Nobuhiro  
Family Name:: OHARA  
City of Residence:: Fukushima  
Country of Residence:: Japan

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**Correspondence Information**

Correspondence Customer Number:: 25944

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/00557	01/22/2003

Foreign Priority Information			
Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-19334	01/29/2002	Yes

Assignee Information		
Assignee Name::	SHIN-ETSU HANDOTAI CO., LTD.	
Street of mailing address::	4-2, Marunouchi 1-chome, Chiyoda-ku	
City of mailing address::	Tokyo	
Country of mailing address::	Japan	